

Patent Abstracts of Japan

PUBLICATION NUMBER

2000147285

PUBLICATION DATE

26-05-00

APPLICATION DATE

09-11-98

APPLICATION NUMBER

10317527

APPLICANT: FURUKAWA ELECTRIC CO LTD:THE;

INVENTOR:

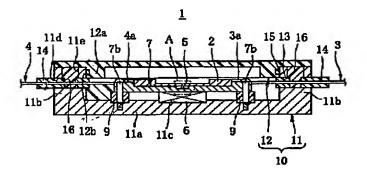
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INT.CL.

G02B 6/122 G02B 6/30 H04B 10/00

TITLE

OPTICAL WAVEGUIDE MODULE



ABSTRACT:

PROBLEM TO BE SOLVED: To provide a compact optical waveguide module allowed to be stably used over a long period even in an environment of high temperature and high humidity and to be easily assembled at the time of its manufacture by sealing the inside and outside of a package to prevent the generation of dew condensation on an optical waveguide component.

SOLUTION: In the optical waveguide module 1, at least a plane type optical waveguide component 2, a temperature sensor 5 for detecting the temperature of the component 2 and a temperature control element 6 for controlling the temperature of the component at a prescribed temperature are stored in a package 10 surrounding these parts. The inside and outside of the package 10 are airtightly sealed by sealing members 15, 16.

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PATENT ABSTRACTS OF JAPAN

(11)Publication number:

2000-147285

(43)Date of publication of application: 26.05.2000

(51)Int.CI.

G02B 6/122

G02B 6/30 H04B 10/00

(21)Application number: 10-317527

(71)Applicant : FURUKAWA ELECTRIC CO

LTD:THE

(22) Date of filing:

09.11.1998

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(54) OPTICAL WAVEGUIDE MODULE

(57) Abstract:

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LEGAL STATUS

[Date of request for examination] [Date of sending the examiner's decision of rejection]

[Kind of final disposal of application other than the examiner's decision of rejection or application converted registration]
[Date of final disposal for application]
[Patent number]
[Date of registration]
[Number of appeal against examiner's decision of rejection]

[Date of requesting appeal against examiner's decision of rejection]

[Date of extinction of right]

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